

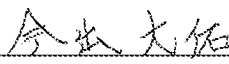
PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6119076

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DAISUKE IMADE	05/12/2020
HIROKI MATSUDA	05/12/2020
SATOSHI ARIMA	05/12/2020
RECEIVING PARTY DATA	
Name:	MITSUMI ELECTRIC CO., LTD.
Street Address:	2-11-2, TSURUMAKI
City:	TAMA-SHI, TOKYO
State/Country:	JAPAN
Postal Code:	206-8567
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16881197
CORRESPONDENCE DATA	
Fax Number:	(212)319-5101
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2123194900
Email:	tmcdonald@HHPATENT.COM
Correspondent Name:	HOLTZ, HOLTZ & VOLEK PC
Address Line 1:	630 NINTH AVENUE
Address Line 2:	SUITE 1010
Address Line 4:	NEW YORK, NEW YORK 10036-3744
ATTORNEY DOCKET NUMBER:	20132
NAME OF SUBMITTER:	TAYLER MCDONALD
SIGNATURE:	/Tayler McDonald/
DATE SIGNED:	05/22/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	
source=20132_Declaration_Assignment#page1.tif	
source=20132_Declaration_Assignment#page2.tif	

Combined Declaration and Assignment

Title of Invention	POWER SUPPLY APPARATUS, SEMICONDUCTOR INTEGRATED CIRCUIT, AND RIPPLE SUPPRESSING METHOD	
<p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to: <input checked="" type="checkbox"/> The attached application, or</p> <p style="margin-left: 150px;"><input type="checkbox"/> United States application or PCT international application number _____ filed on _____.</p> <p>The above-identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>In consideration of value received, I sell and assign to <u>MITSUMI ELECTRIC CO., LTD.</u>, having a business address at <u>2-11-2, Tsurumaki, Tama-shi, Tokyo, 206-8567, JAPAN</u>, its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention, and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of intellectual property, including rights of priority, resulting from the filing of any of said applications.</p> <p>I authorize said Assignee to file and prosecute an application or applications for patent for said invention as the applicant, and I request any official whose duty it is to issue patents, to issue any patent on said invention to said Assignee.</p> <p>I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p>		
LEGAL NAME OF INVENTOR		
Daisuke IMADE		MAR 12, 2020
Inventor (printed name)	Signature	Date

Holtz, Holtz & Volek PC
 630 Ninth Avenue, Suite 1010, New York, NY 10036-3744
 Tel. (212) 319-4900 Fax. (212) 319-5101

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LEGAL NAME OF INVENTOR		
Hiroki MATSUDA	<i>Hiroki Matsuda</i>	May 12, 2020
Inventor (printed name)	Signature	Date

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Combined Declaration and Assignment

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☐ United States application or PCT international application
number _____ filed on _____.

The above-identified application was made or authorized to be made by me.

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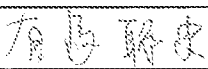
In consideration of value received, I sell and assign to MITSUMI ELECTRIC CO., LTD., having a business address at 2-11-2, Tsurumaki, Tama-shi, Tokyo, 206-8567, JAPAN, its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention, and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of intellectual property, including rights of priority, resulting from the filing of any of said applications.

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I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.

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LEGAL NAME OF INVENTOR

Satoshi ARIMA		May 12, 2020
Inventor (printed name)	Signature	Date

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RECORDED: 05/22/2020

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